



#### 0.5A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

#### **Features**

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- **High Conductance**
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 5)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOD-123
- Case Material: Molded Plastic, "Green" Molding Compound (Note 5). UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D •
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe) Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.01 grams (approximate)



Top View

## **Maximum Ratings** $@T_A = 25^{\circ}C$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Average Rectified Output Current (See Figure 4)	Io	0.5	A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	5.5	А

# **Thermal Characteristics**

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Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance Junction to Ambient Air (Note 2) $T_A = 25^{\circ}C$	$R_{\theta JA}$	385		°C/W
Thermal Resistance Junction to Ambient Air (Note 3) $T_A = 25^{\circ}C$	R <sub>0JA</sub>	325	_	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to	+150	°C

# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	Test Conditions	
Minimum Reverse Breakdown Voltage (Note 4)	V <sub>(BR)R</sub>	40	V	$I_R = 20\mu A$	
Maximum Forward Voltage Drop	V <sub>FM</sub>	0.510 0.620 0.460 0.610	V	$\begin{split} I_F &= 0.5A, \ T_J = 25^\circ C \\ I_F &= 1.0A, \ T_J = 25^\circ C \\ I_F &= 0.5A, \ T_J = 100^\circ C \\ I_F &= 1.0A, \ T_J = 100^\circ C \end{split}$	
Maximum Leakage Current (Note 4)	IRM	10 20	μA	$V_R = 20V, T_J = 25^{\circ}C$ $V_R = 40V, T_J = 25^{\circ}C$	
		5.0 13	mA	$V_R = 20V, T_J = 100^{\circ}C$ $V_R = 40V, T_J = 100^{\circ}C$	
Total Capacitance	CT	170	pF	$f = 1MHz$ , $V_R = 0V DC$	

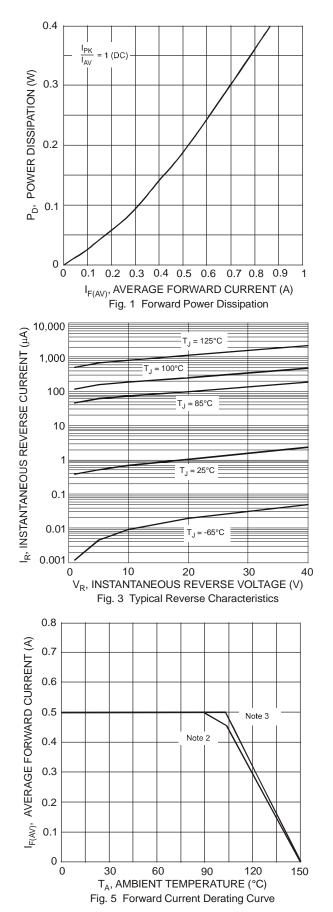
Notes: 1. No purposefully added lead. Halogen and Antimony Free.

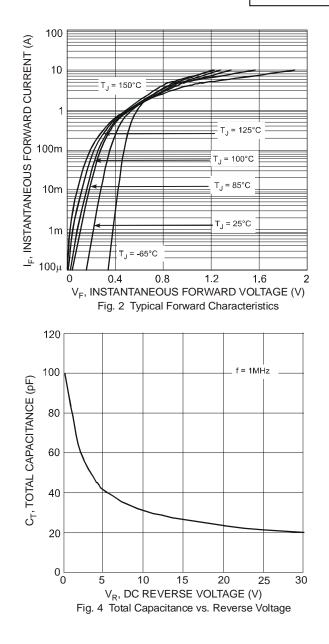
2. FR-4 PCB, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.

Polymide PCB, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
Short duration pulse test used to minimize self-heating effect.

5. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.









**B0540W** 

## Ordering Information (Note 6)

Part Number	Case	Packaging
B0540W-7-F	SOD-123	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

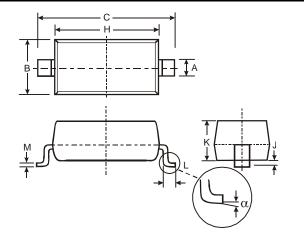
### **Marking Information**



SF = Product Type Marking Code YM = Date Code Marking Y = Year (ex: N = 2002) M = Month (ex: 9 = September)

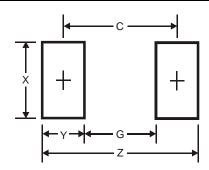
Date Code Key								,	•	,					
Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L	М	Ν	Р	R	S	Т	U	V	W	Х	Y	Z
Month	Jan	Fe	b	Mar	Apr	Мау	Ju	n	Jul	Aug	Sep	Oc	t	Nov	Dec
Code	1	2		3	4	5	6	i i	7	8	9	0		Ν	D

## **Package Outline Dimensions**



SOD-123					
Dim	Min	Max			
Α	0.55	Тур			
В	1.40	1.70			
С	3.55	3.85			
Н	2.55	2.85			
J	0.00 0.10				
κ	1.00 1.35				
L	0.25	0.40			
М	0.10	0.15			
α	0	8°			
All Dimensions in mm					
All Dimensions in mm					

## **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	4.9
G	2.5
Х	0.7
Y	1.2
C	3.7

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